



## International Conference on

# EMS/Contract Manufacturing: The Indian Perspective

September 2, 2008, Convention Centre, Bangalore International Exhibition Centre, Bangalore, India

### TENTATIVE PROGRAMME

- 08:30 - 10:00 hrs : **Registration**
- 10:00 - 11:10 hrs : **Inaugural Session: electronicIndia 2008**
- : **Welcome Address:** *Manmeet Sabarwal, Managing Director, MMI India Pvt. Ltd.*
  - : **Introduction:** *Klaus Dittrich, Managing Director, Messe Muenchen GmbH*
  - : **Keynote Address:** *Mr. T. K. Misra, EPCOS India Pvt. Ltd., India*
  - : **Association Address:** *Anil Kumar, President, Indian Printed Circuit Association (IPCA)*
  - : **Vote of Thanks:** *Kurt Schraudy, Director, Messe Muenchen GmbH*
  - : **Lighting of Lamp followed by visit to exhibition halls**
  - : **Tea/ Coffee Break**
- 11:30 - 13.00 hrs : **Session-I: Panel Discussion-Top Management EMS/OEMS and ODM's - Business Opportunities and Challenges in India**
- : **Introduction:** *Soni Saran Singh, Chief Conference Convenor & Executive Director, NMTronics and Managing Director iNETest Technologies*
  - : *Mr. Sachin Saxena, Director – Operations, Nokia India Pvt. Ltd.*
  - : *Mr. Josh Foulger, Head of Outsourcing Nokia India, Nokia India Pvt. Ltd.*
  - : *Mr. Kris Batta, Sr. Director, Jabil India Pvt. Ltd.*
  - : *Mr. Javed Ahmed, General Manager, APC India Pvt. Ltd.*
  - : *Mr. Satendra Singh, Head – India Manufacturing Operations, Nokia Siemens Network [NSN] Pvt. Ltd.*
  - : *Mr. Sukhvinder Kumar, General Manager – Indian Operations, ELCOTEQ Electronics India Pvt. Ltd.*
  - : *DELL India Pvt. Ltd., M. R. Sundaresan, Operations Director*
  - : **Networking Lunch**
- 14:00 - 16:00 hrs : **Session II: EMS Emerging Trends and Challenges**
- 14:00 - 14:20 hrs : **EMS-Markets and Trends,** *Jens Uwe Fuhrmann, Fuhrmann Consulting Network*
  - 14:20 - 14:40 hrs : **Indian Industry on the Verge of Taking a Leap,** *V. Niju, Frost and Sullivan*
  - 14:40 - 15:00 hrs : **EMS/ODM opportunities in India,** *Arindam Ganguli, Milagrow*
  - 15:00 - 15:15 hrs : **Challenge for EMS/ODM Companies-Indian Perspective,** *K. R. Sripathy, Kaynes Technology*
  - 15:15 - 15:30 hrs : **Challenge for EMS/ODM Companies,** *Kelvin Ong, Siemens*
  - 15:30 - 15:45 hrs : **Outsourcing of Semiconductor Chip Design,** *Ravi Kumar, HCL Technologies*
  - : **Tea / Coffee Break**
- 16:20 - 18:00 hrs : **Session III: Environmental, Quality and Standardisation Issues**
- 16:20 - 16:35 hrs : **New Tools for process Optimization,** *Kenneth Koh, Siemens*
  - 16:35 - 16:50 hrs : **Process Control with LF Hand Soldering,** *Speaker, OK International*
  - 16:50 - 17:05 hrs : **Impact of Placement Quality on SMT Manufacturing Costs,** *Ir. Sjef van Gastel, Assembleon*
  - 17:05 - 17:20 hrs : **Doublesided Lead Free BGA Rework,** *Paul Wood, OK International*
  - 17:20 - 17:35 hrs : **Solder Paste Printing Process Control,** *Thorsten Niermeyer, Koh Young Technology*